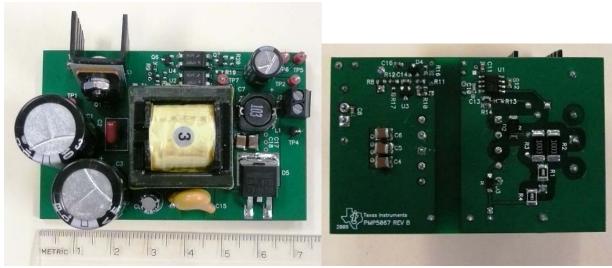


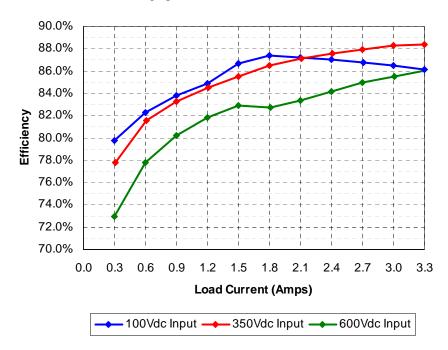
1 Photo

The photographs below show the top and bottom views of the PMP5067 Rev C demo board. The circuit is built on a PMP5067 Rev B PWB.



2 Efficiency

The efficiency data is shown in the tables and graph below.





| 1 | 0 | 0 | ۷ | d | c |
|---|---|---|---|---|---|
|---|---|---|---|---|---|

| lout | Vout | Vin (Vdc) | lin (mAdc) | Pin | Pout | Losses | Efficiency |
|-------|-------|-----------|------------|-------|-------|--------|------------|
| 0.300 | 12.01 | 99.9 | 45.2 | 4.52 | 3.60 | 0.91 | 79.8% |
| 0.601 | 12.01 | 100.9 | 86.9 | 8.77 | 7.22 | 1.55 | 82.3% |
| 0.899 | 12.01 | 100.8 | 127.8 | 12.88 | 10.80 | 2.09 | 83.8% |
| 1.201 | 12.01 | 100.7 | 168.7 | 16.99 | 14.42 | 2.56 | 84.9% |
| 1.502 | 12.00 | 100.6 | 206.6 | 20.78 | 18.02 | 2.76 | 86.7% |
| 1.800 | 12.00 | 100.5 | 245.9 | 24.71 | 21.60 | 3.11 | 87.4% |
| 2.100 | 12.00 | 100.5 | 287.4 | 28.88 | 25.20 | 3.68 | 87.2% |
| 2.403 | 12.00 | 100.4 | 330.1 | 33.14 | 28.84 | 4.31 | 87.0% |
| 2.710 | 12.00 | 100.3 | 373.7 | 37.48 | 32.52 | 4.96 | 86.8% |
| 3.004 | 12.00 | 100.9 | 413 | 41.67 | 36.05 | 5.62 | 86.5% |
| 3.304 | 12.00 | 100.9 | 456 | 46.01 | 39.65 | 6.36 | 86.2% |

350Vdc

| lout | Vout | Vin (Vdc) | lin (mAdc) | Pin | Pout | Losses | Efficiency |
|-------|-------|-----------|------------|-------|-------|--------|------------|
| 0.306 | 12.01 | 353.3 | 13.37 | 4.72 | 3.68 | 1.05 | 77.8% |
| 0.607 | 12.01 | 353.3 | 25.30 | 8.94 | 7.29 | 1.65 | 81.6% |
| 0.900 | 12.01 | 353.3 | 36.72 | 12.97 | 10.81 | 2.16 | 83.3% |
| 1.206 | 12.01 | 353.3 | 48.5 | 17.14 | 14.48 | 2.65 | 84.5% |
| 1.501 | 12.01 | 353.2 | 59.7 | 21.09 | 18.03 | 3.06 | 85.5% |
| 1.798 | 12.00 | 353.2 | 70.6 | 24.94 | 21.58 | 3.36 | 86.5% |
| 2.108 | 12.00 | 353.2 | 82.2 | 29.03 | 25.30 | 3.74 | 87.1% |
| 2.405 | 12.00 | 353.2 | 93.3 | 32.95 | 28.86 | 4.09 | 87.6% |
| 2.701 | 12.00 | 353.1 | 104.4 | 36.86 | 32.41 | 4.45 | 87.9% |
| 3.004 | 12.00 | 353.1 | 115.6 | 40.82 | 36.05 | 4.77 | 88.3% |
| 3.302 | 12.00 | 353.1 | 126.9 | 44.81 | 39.62 | 5.18 | 88.4% |

600Vdc

| lout | Vout | Vin (Vdc) | lin (mAdc) | Pin | Pout | Losses | Efficiency |
|-------|-------|-----------|------------|-------|-------|--------|------------|
| 0.304 | 12.01 | 600.2 | 8.34 | 5.01 | 3.65 | 1.35 | 72.9% |
| 0.603 | 12.01 | 600.2 | 15.51 | 9.31 | 7.24 | 2.07 | 77.8% |
| 0.896 | 12.01 | 600.2 | 22.36 | 13.42 | 10.76 | 2.66 | 80.2% |
| 1.197 | 12.01 | 600.2 | 29.27 | 17.57 | 14.38 | 3.19 | 81.8% |
| 1.496 | 12.01 | 600.2 | 36.10 | 21.67 | 17.97 | 3.70 | 82.9% |
| 1.805 | 12.00 | 600.2 | 43.6 | 26.17 | 21.66 | 4.51 | 82.8% |
| 2.102 | 12.00 | 600.2 | 50.4 | 30.25 | 25.22 | 5.03 | 83.4% |
| 2.399 | 12.00 | 600.1 | 57.0 | 34.21 | 28.79 | 5.42 | 84.2% |
| 2.698 | 12.00 | 600.1 | 63.5 | 38.11 | 32.38 | 5.73 | 85.0% |
| 3.007 | 12.00 | 600.1 | 70.3 | 42.19 | 36.08 | 6.10 | 85.5% |
| 3.308 | 12.00 | 600.1 | 76.9 | 46.15 | 39.70 | 6.45 | 86.0% |

3 Standby Mode Power Consumption

The tables below show the input power and efficiency during light load operation.

100Vdc

| lout | Vout | Vin (Vdc) | lin (mA) | Pin (mW) | Pout (mW) | Losses | Efficiency |
|-------|-------|-----------|----------|----------|-----------|--------|------------|
| 0.000 | 12.04 | 101.3 | 1.74 | 176 | 0 | 176 | 0.0% |
| 0.024 | 12.02 | 101.3 | 4.93 | 499 | 288 | 211 | 57.8% |
| 0.049 | 12.02 | 101.3 | 8.55 | 866 | 589 | 277 | 68.0% |

350Vdc

| lout | Vout | Vin (Vdc) | lin (mA) | Pin (mW) | Pout (mW) | Losses | Efficiency | | | |
|-------|-------|-----------|----------|----------|-----------|--------|------------|--|--|--|
| 0.000 | 12.03 | 352.4 | 0.82 | 289 | 0 | 289 | 0.0% | | | |
| 0.025 | 12.01 | 352.4 | 1.79 | 631 | 300 | 331 | 47.6% | | | |
| 0.049 | 12.01 | 352.4 | 2.75 | 969 | 588 | 381 | 60.7% | | | |
| | | | | | | | | | | |

600Vdc

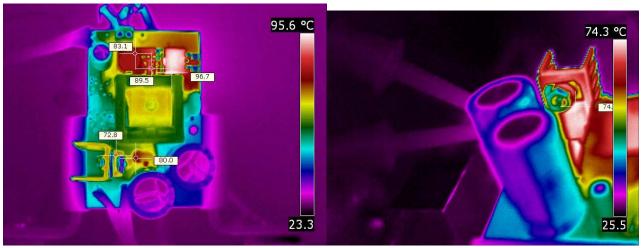
| lout | Vout | Vin (Vdc) | lin (mA) | Pin (mW) | Pout (mW) | Losses | Efficiency |
|-------|-------|-----------|----------|----------|-----------|--------|------------|
| 0.000 | 12.02 | 600.2 | 0.89 | 534 | 0 | 534 | 0.0% |
| 0.025 | 12.01 | 600.2 | 1.47 | 882 | 300 | 582 | 34.0% |
| 0.049 | 12.01 | 600.3 | 2.10 | 1261 | 588 | 672 | 46.7% |



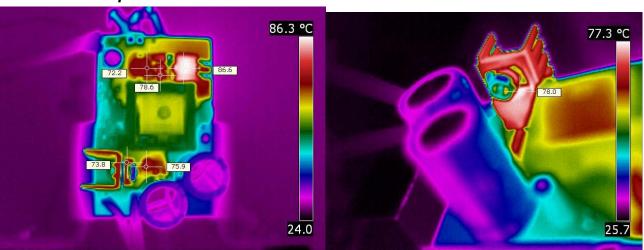
4 Thermal Images

The thermal images below show a top view (left) of the board and close up view (right) of the main FET (Q1). The ambient temperature was 26° C with no forced air flow. The output was loaded with 3.3A.

4.1 100VDC Input



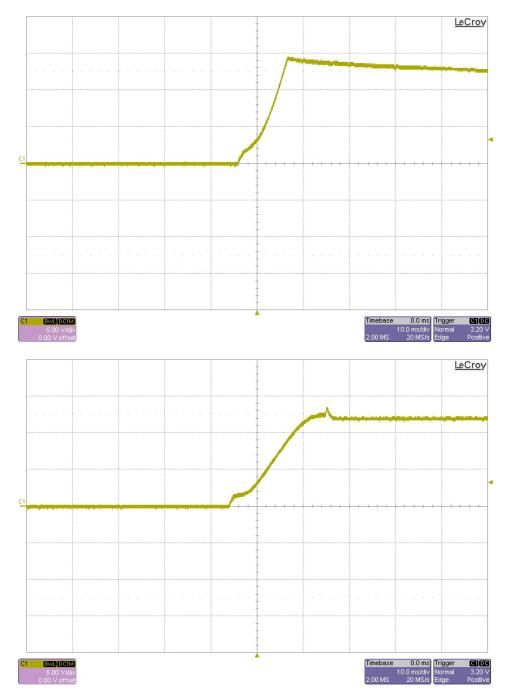
4.2 600VDC Input





5 Startup

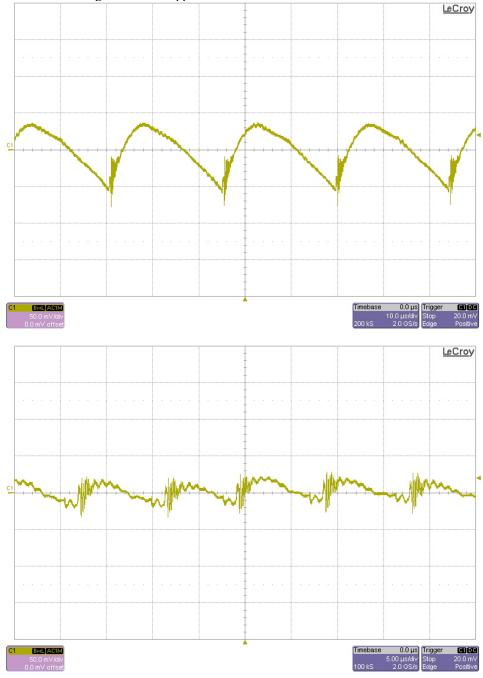
The output voltage at startup is shown in the images below. The input was 350VDC. For the top image, the output was unloaded. For the bottom image, the output was loaded with 3.3A.





6 Output Ripple Voltage - Full Load

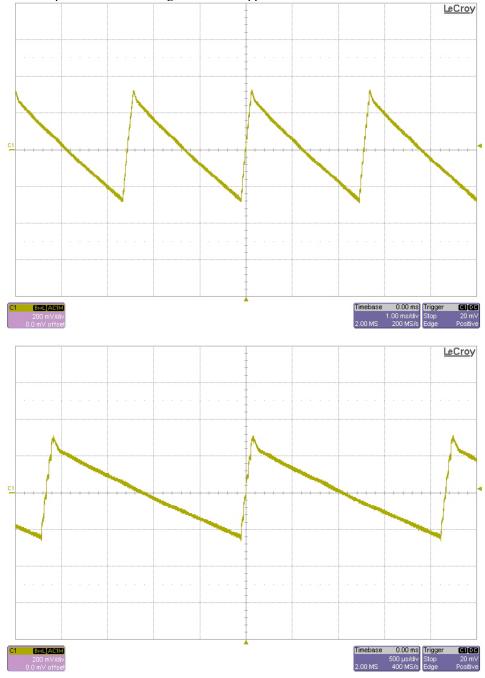
The output ripple voltage during full load operation is shown in the plots below. The top image shows the ripple with a 100VDC input. The bottom image shows the ripple with a 600VDC.





7 Output Ripple Voltage – Light Load

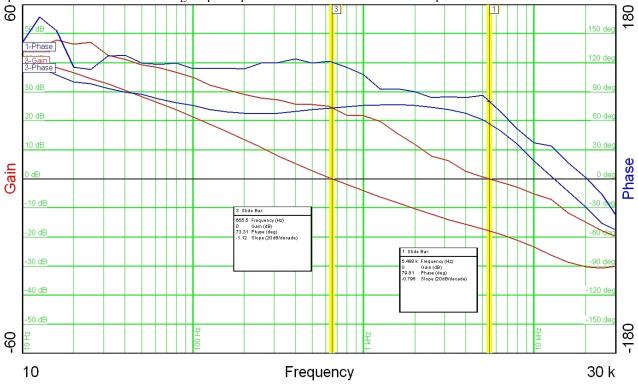
The output ripple voltage during light load operation (100mA) is shown in the plots below. The top image shows the ripple with a 100VDC input. The bottom image shows the ripple with a 600VDC.





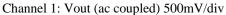
Loop Response 8

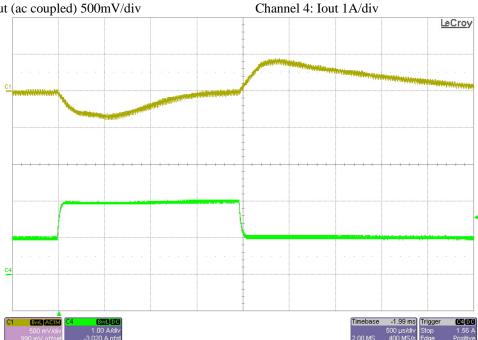
The image below shows the loop response of the converter. The upper gain/phase plot was measured with a 600Vdc input and a 3.3A load. The lower gain/phase plot was measured with a 100Vdc input and a 3.3A load.



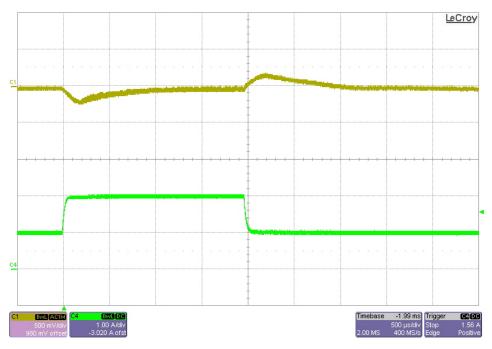
Load Transients

The images below show the response to a 1A to 2A load transient. For the top image, the input voltage was set to 100VDC. For the bottom image, the input was set to 600VDC.



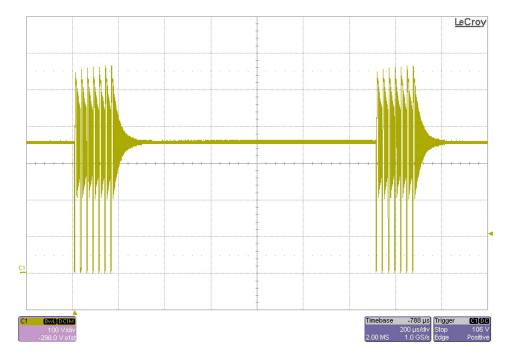




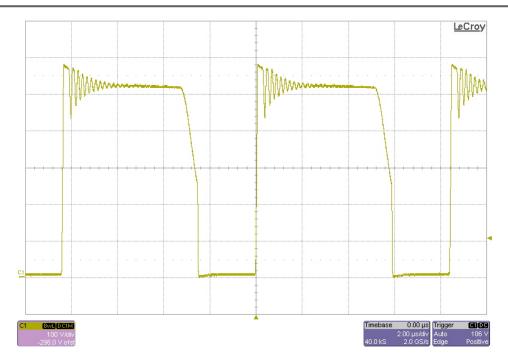


10 Switching Waveforms

The images below show the drain-to-source voltage waveform on the primary MOSFET (Q1). The top image demonstrates burst mode operation, where the load was 200mA and the input was set to 350VDC. In the bottom image, the load was 3.3A and the input was 350VDC.







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